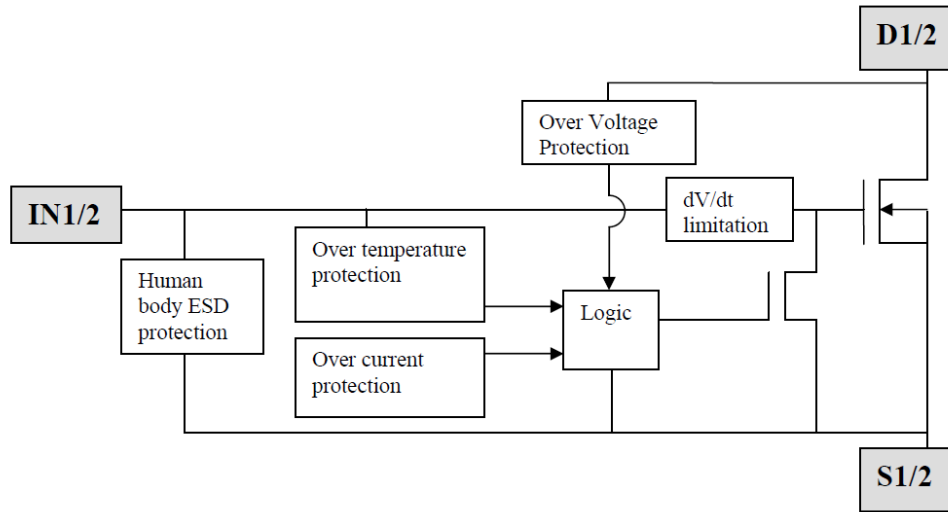


## Functional Block Diagram



## Application Information

- Two Completely Isolated Independent Channels
- Especially Suited for Loads with a High In-rush Current Such as Lamps and Motors
- All Types of Resistive, Inductive and Capacitive Loads in Switching Applications
- $\mu\text{C}$  Compatible Power Switch for 12V and 24V DC Applications
- Replaces Electromechanical Relays and Discrete Circuits
- Linear Mode Capability — the current-limiting protection circuitry is designed to deactivate at low  $V_{\text{DS}}$  to minimize on-state power dissipation. The maximum DC operating current is therefore determined by the thermal capability of the package or board combination, rather than by the protection circuitry. This does not compromise the product's ability to self-protect at low  $V_{\text{DS}}$

## Absolute Maximum Ratings (@ $T_{\text{A}} = +25^{\circ}\text{C}$ , unless otherwise stated.)

Characteristic	Symbol	Value	Unit
Continuous Drain-Source Voltage	$V_{\text{DS}}$	60	V
Drain-Source Voltage For Short Circuit Protection	$V_{\text{DS(SC)}}$	16	V
Continuous Input Voltage	$V_{\text{IN}}$	-0.5 to +6	V
Continuous Input Current @ $-0.2\text{V} \leq V_{\text{IN}} \leq 6\text{V}$	$I_{\text{IN}}$	No limit $ I_{\text{IN}}  \leq 2$	mA
Continuous Input Current @ $V_{\text{IN}} < -0.2\text{V}$ or $V_{\text{IN}} > 6\text{V}$			
Pulsed Drain Current @ $V_{\text{IN}} = 3.3\text{V}$	$I_{\text{DM}}$	5	A
Pulsed Drain Current @ $V_{\text{IN}} = 5\text{V}$	$I_{\text{DM}}$	6	A
Continuous Source Current (Body Diode) (Note 5)	$I_{\text{S}}$	2.5	A
Pulsed Source Current (Body Diode)	$I_{\text{SM}}$	10	A
Unclamped Single Pulse Inductive Energy, $T_{\text{J}} = +25^{\circ}\text{C}$ , $I_{\text{D}} = 0.5\text{A}$ , $V_{\text{DD}} = 24\text{V}$	$E_{\text{AS}}$	120	mJ
Electrostatic Discharge (Human Body Model)	$V_{\text{HBM}}$	4,000	V
Charged Device Model	$V_{\text{CDM}}$	1,000	V

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

## Recommended Operating Conditions

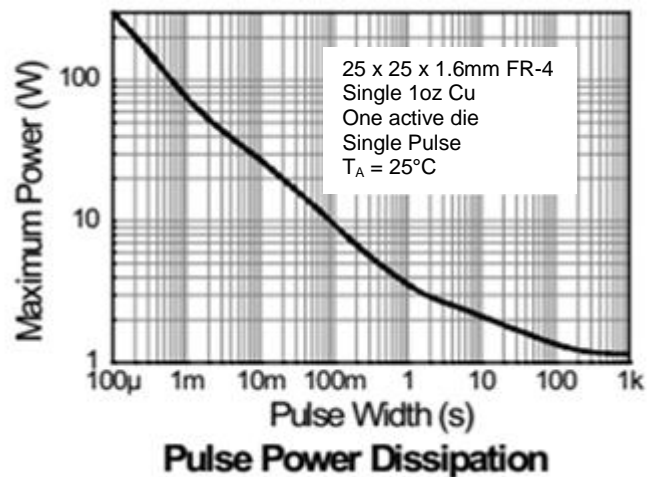
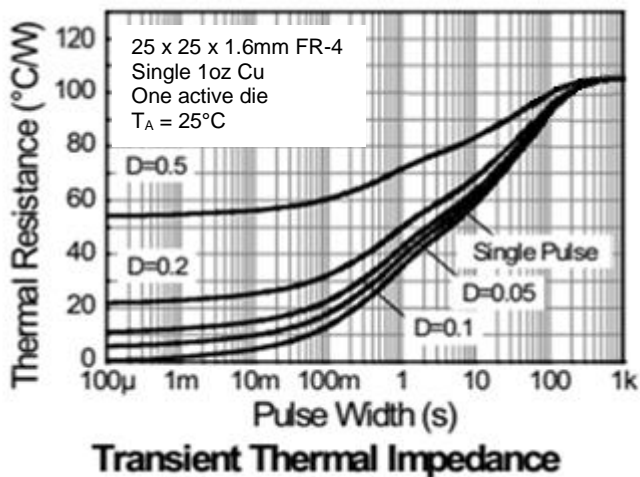
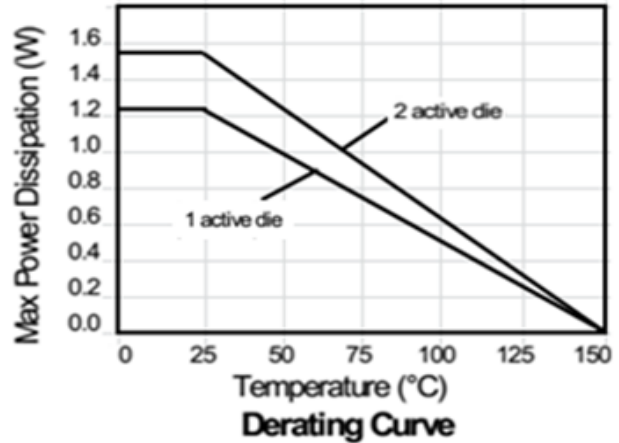
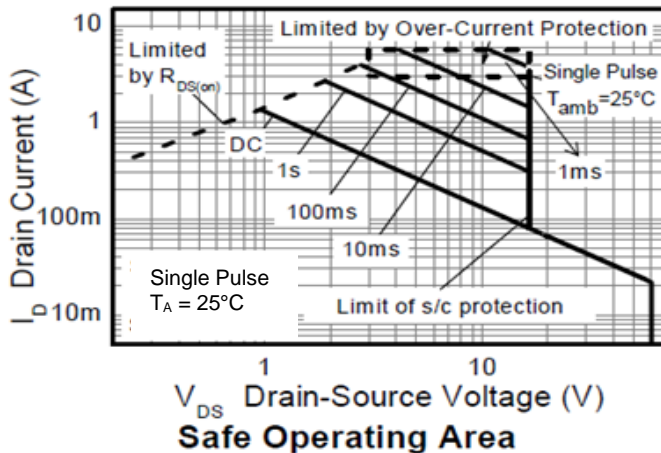
The ZXMS6005DN8 is optimized for use with  $\mu\text{C}$  operating from 3.3V and 5V supplies.

Characteristic	Symbol	Min	Max	Unit
Input Voltage Range	$V_{IN}$	0	5.5	V
Ambient Temperature Range	$T_A$	-40	+125	$^{\circ}\text{C}$
High Level Input Voltage for MOSFET to be On	$V_{IH}$	3	5.5	V
Low Level Input Voltage for MOSFET to be Off	$V_{IL}$	0	0.7	V
Peripheral Supply Voltage (Voltage to which load is referred)	$V_P$	0	16	V

## Thermal Characteristics (@ $T_A = +25^{\circ}\text{C}$ , unless otherwise stated.)

Characteristic	Symbol	Value	Unit
Power Dissipation at $T_A = +25^{\circ}\text{C}$ (Note 5)	$P_D$	1.21	W
Linear Derating Factor		9.7	$\text{mW}/^{\circ}\text{C}$
Power Dissipation at $T_A = +25^{\circ}\text{C}$ (Note 6)	$P_D$	1.56	W
Linear Derating Factor		12.5	$\text{mW}/^{\circ}\text{C}$
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	103	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	81	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction to Case (Note 7)	$R_{\theta JC}$	13.5	$^{\circ}\text{C}/\text{W}$
Operating Temperature Range	$T_J$	-40 to +150	$^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-55 to +150	$^{\circ}\text{C}$

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.  
7. Thermal resistance between junction and the mounting surfaces of drain and source pins.

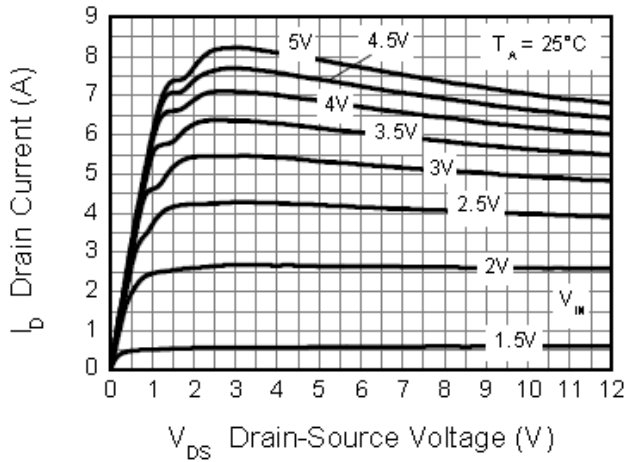


**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

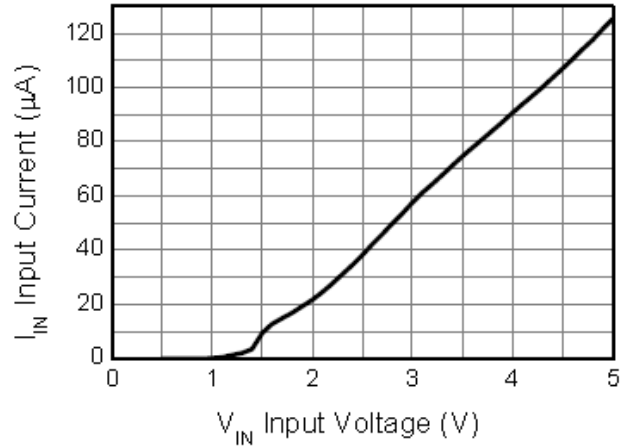
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>Static Characteristics</b>						
Drain-Source Clamp Voltage	V <sub>DS(AZ)</sub>	60	65	70	V	I <sub>D</sub> = 10mA
Off-State Drain Current	I <sub>DSS</sub>	—	—	1	μA	V <sub>DS</sub> = 12V, V <sub>IN</sub> = 0V
		—	—	2		V <sub>DS</sub> = 36V, V <sub>IN</sub> = 0V
Input Threshold Voltage	V <sub>IN(TH)</sub>	0.7	1	1.5	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1mA
Input Current	I <sub>IN</sub>	—	60	100	μA	V <sub>IN</sub> = 3V
		—	120	200		V <sub>IN</sub> = 5V
Input Current while Over-Temperature Active	—	—	—	300	μA	V <sub>IN</sub> = 5V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	—	170	250	mΩ	V <sub>IN</sub> = 3V, I <sub>D</sub> = 1A
		—	150	200		V <sub>IN</sub> = 5V, I <sub>D</sub> = 1A
Continuous Drain Current (Note 5)	I <sub>D</sub>	1.4	—	—	A	V <sub>IN</sub> = 3V; T <sub>A</sub> = +25°C
		1.6	—	—		V <sub>IN</sub> = 5V; T <sub>A</sub> = +25°C
Continuous Drain Current (Note 6)		1.7	—	—		V <sub>IN</sub> = 3V; T <sub>A</sub> = +25°C
		1.8	—	—		V <sub>IN</sub> = 5V; T <sub>A</sub> = +25°C
Current Limit (Note 8)	I <sub>D(LIM)</sub>	2.2	5	—	A	V <sub>IN</sub> = 3V
		3.3	7	—		V <sub>IN</sub> = 5V
<b>Dynamic Characteristics</b>						
Turn On Delay Time	t <sub>D(ON)</sub>	—	6	—	μs	V <sub>DD</sub> = 12V, I <sub>D</sub> = 0.5A, V <sub>GS</sub> = 5V
Rise Time	t <sub>R</sub>	—	14	—	μs	
Turn Off Delay Time	t <sub>D(OFF)</sub>	—	34	—	μs	
Fall Time	t <sub>F</sub>	—	19	—	μs	
<b>Over-Temperature Protection</b>						
Thermal Overload Trip Temperature (Note 9)	T <sub>JT</sub>	+150	+175	—	°C	—
Thermal Hysteresis (Note 9)	ΔT <sub>JT</sub>	—	+10	—	°C	—

- Notes:
- The drain current is restricted only when the device is in saturation (see graph "Typical Output Characteristic"). This allows the device to be used in the onstate without interference from the current limit. The device is fully protected at all drain currents, as the low power dissipation generated outside saturation makes current limit unnecessary.
  - Over-temperature protection is designed to prevent device destruction under fault conditions. Fault conditions are considered as "outside" normal operating range, so this part is not designed to withstand over-temperature for extended periods.

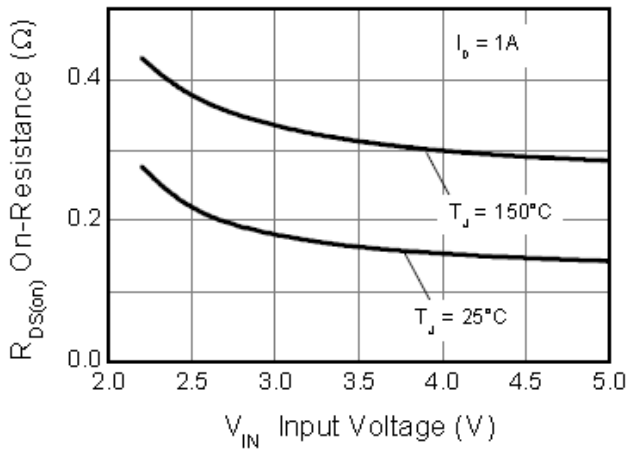
**Typical Characteristics (Cont.)**



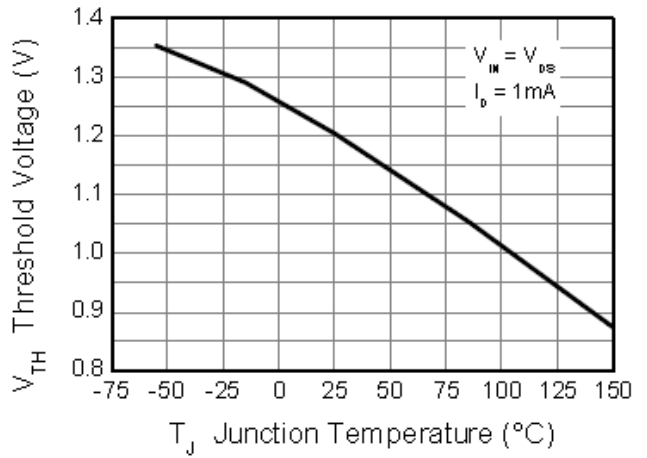
**Typical Output Characteristic**



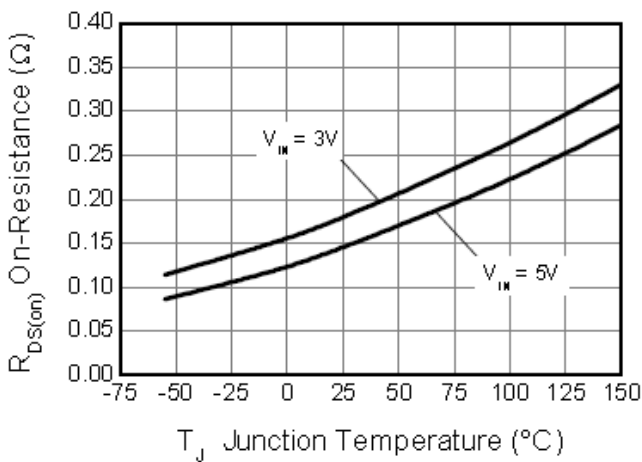
**Input Current vs Input Voltage**



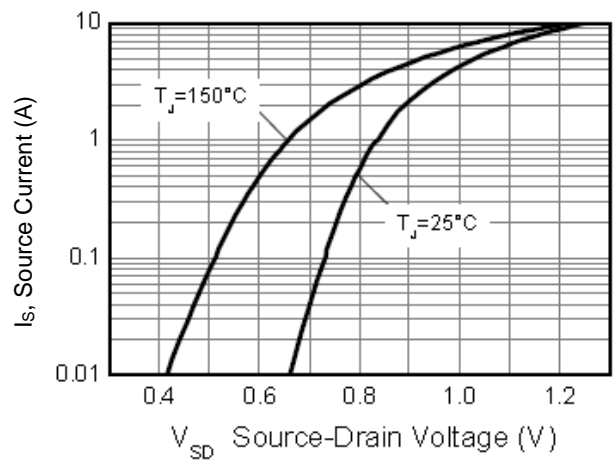
**On-Resistance vs Input Voltage**



**Threshold Voltage vs Temperature**

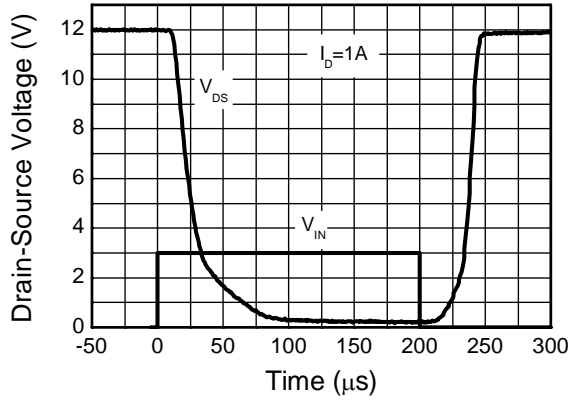


**On-Resistance vs Temperature**

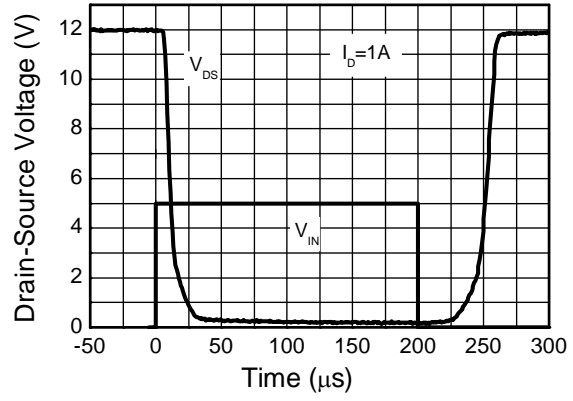


**Reverse Diode Characteristic**

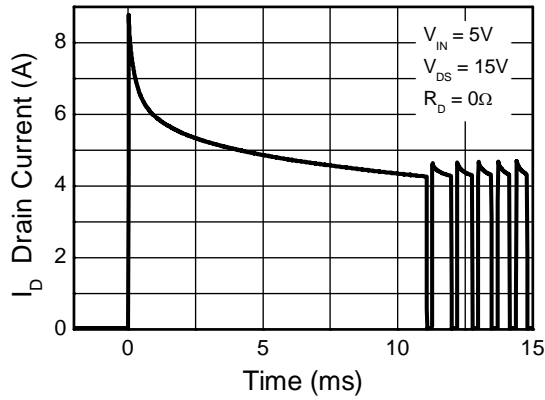
**Typical Characteristics (Cont.)**



**Switching Speed**



**Switching Speed**

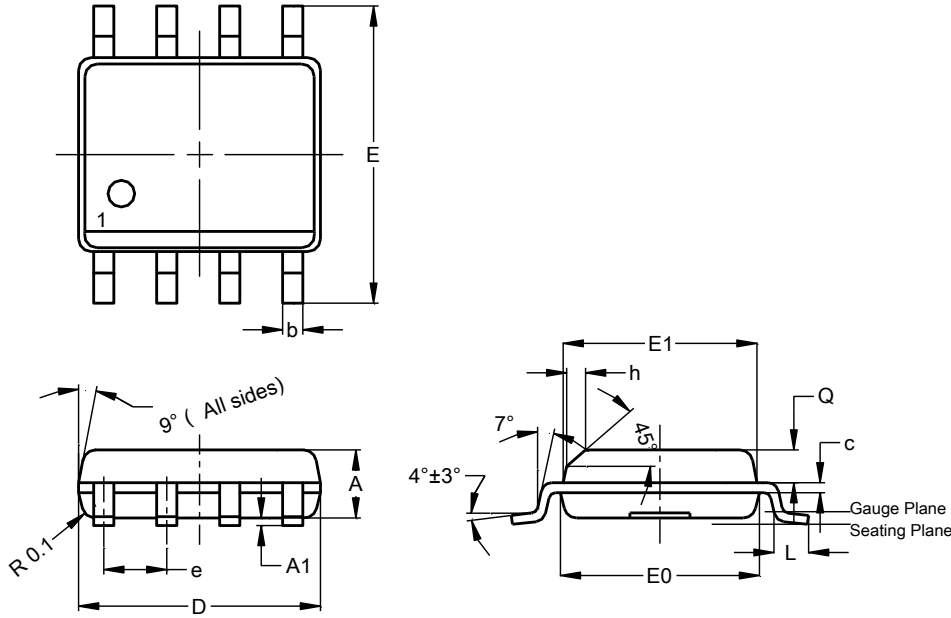


**Typical Short Circuit Protection**

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SO-8**

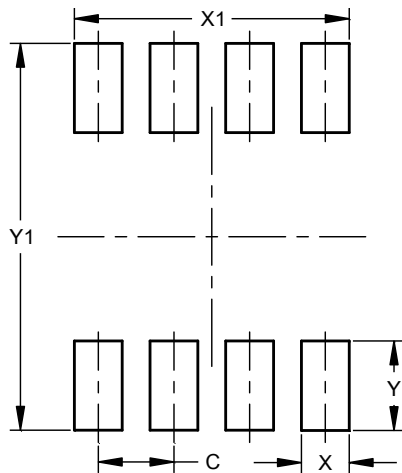


SO-8			
Dim	Min	Max	Typ
A	1.40	1.50	1.45
A1	0.10	0.20	0.15
b	0.30	0.50	0.40
c	0.15	0.25	0.20
D	4.85	4.95	4.90
E	5.90	6.10	6.00
E1	3.80	3.90	3.85
E0	3.85	3.95	3.90
e	--	--	1.27
h	-	--	0.35
L	0.62	0.82	0.72
Q	0.60	0.70	0.65
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SO-8**



Dimensions	Value (in mm)
C	1.27
X	0.802
X1	4.612
Y	1.505
Y1	6.50

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